



P-Channel 40 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^a	Q _g (Typ.)			
- 40	$0.015 \text{ at V}_{GS} = -10 \text{ V}$	- 16.1	33 nC			
- 40	0.022 at V _{GS} = - 4.5 V	- 13.3	33 110			

FEATURES

- Halogen-free According to IEC 61249-2-21
- TrenchFET® Power MOSFET
- 100 % R_g Tested
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC



COMPLIANT HALOGEN **FREE**

APPLICATIONS

- Load Switch
- POL



P-Channel MOSFET

		SO-8		
s	1		8	D
S	2		7	D
S	3		6	D
G	4		5	D
		Top View	J	

Ordering Information: Si4401DDY-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter Drain-Source Voltage Gate-Source Voltage		Symbol	Limit	Unit	
		V _{DS}	- 40		
		V _{GS}	± 20	V	
	T _C = 25 °C		- 16.1		
Continuous Drain Current /T 150 °C	T _C = 70 °C	1 ,	- 12.9		
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	I _D	- 10.2 ^{b, c}		
	T _A = 70 °C		- 8.2 ^{b, c}		
Pulsed Drain Current		I _{DM}	- 50	A	
Continue Course Dunin Diada Courset	T _C = 25 °C		- 5.3		
Continous Source-Drain Diode Current	T _A = 25 °C	ls —	- 2.1 ^{b, c}		
Single Pulse Avalanche Current	. 0.4	I _{AS}	- 28		
Single Pulse Avalanche Energy L = 0.1 mH		E _{AS}	39	mJ	
	T _C = 25 °C		6.3		
Maximum Power Dissipation	T _C = 70 °C		4	w	
	T _A = 25 °C	P _D	2.5 ^{b, c}	VV	
	T _A = 70 °C		1.6 ^{b, c}		
Operating Junction and Storage Temperature	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	37	50	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	16	20	C/VV		

Notes:

- a. Based on T_C = 25 °C. b. Surface mounted on 1" x 1" FR4 board.
- d. Maximum under steady state conditions is 85 °C/W.



SPECIFICATIONS $T_J = 25 ^{\circ}C$, Parameter	Symbol	Test Conditions	Min.	Tvn	Max.	Unit	
Static	Syllibol	rest conditions	IVIIII.	Тур.	IVIAX.	Ollit	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = - 250 μA	- 40			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	30 2 .		- 36		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	l _D = - 250 μA		5			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = -250 \mu\text{A}$	- 1.2		- 2.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Cano Courso Lourage	-033	$V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}$			- 1	117	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 40 V, V _{GS} = 0 V, T _J = 55 °C			- 5	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	- 25			Α	
		V _{GS} = - 10 V, I _D = - 10.2 A		0.012	0.015	+	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 8.4 A		0.018	0.022	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 10.2 A		37		S	
Dynamic ^b					1		
Input Capacitance	C _{iss}			3007			
Output Capacitance	C _{oss}	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		335		pF	
Reverse Transfer Capacitance	C _{rss}			291			
Total Gate Charge	Q_{g}	$V_{DS} = -20 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -10.2 \text{ A}$		64	95	nC	
				33	50		
Gate-Source Charge	Q_{gs}	$V_{DS} = -20 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -10.2 \text{ A}$		9.8			
Gate-Drain Charge	Q _{gd}			15.7			
Gate Resistance	R_g	f = 1 MHz	0.4	2	4	Ω	
Turn-On Delay Time	t _{d(on)}			57	86		
Rise Time	t _r	V_{DD} = - 20 V, R_L = 2.4 Ω		50	75		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 8.2 A, V_{GEN} = - 4.5 V, R_g = 1 Ω		40	60		
Fall Time	t _f			17	26	ns	
Turn-On Delay Time	t _{d(on)}			13	20	115	
Rise Time	t _r	V_{DD} = - 20 V, R_L = 2.4 Ω		11	20		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 8.2 A, V_{GEN} = - 10 V, R_g = 1 Ω		45	68		
Fall Time	t _f			9	18		
Drain-Source Body Diode Characteristi	cs						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			- 5.3	Α	
Pulse Diode Forward Current	I _{SM}				- 50		
Body Diode Voltage	V_{SD}	I _S = - 8.2 A, V _{GS} = 0 V		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			36	54	ns	
Body Diode Reverse Recovery Charge	Q_{rr}	I _F = - 8.2 A, dl/dt = 100 A/μs, T _J = 25 °C	<u> </u>	41	62	nC	
Reverse Recovery Fall Time t _a		σ.ε. τι, απαι – του τύμο, τη – 20 σ		20		ns	
Reverse Recovery Rise Time	t _b			16			

Notes:

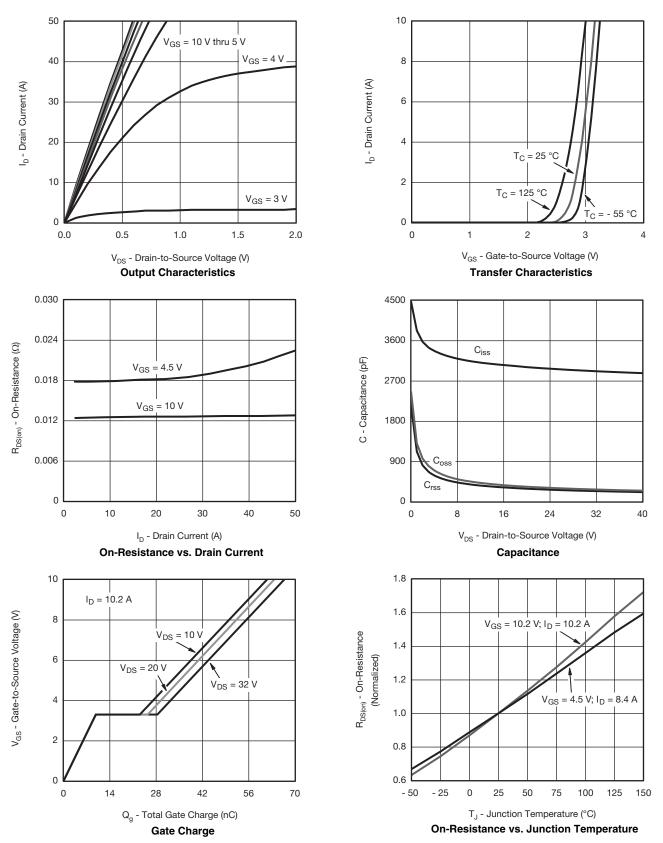
- a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

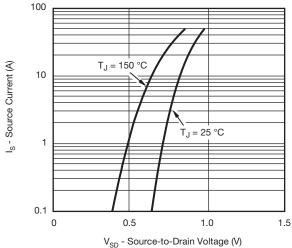


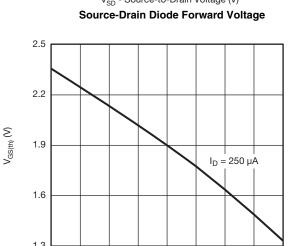


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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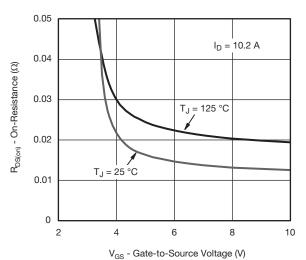


125

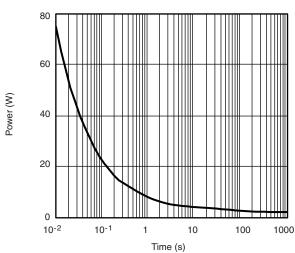
150



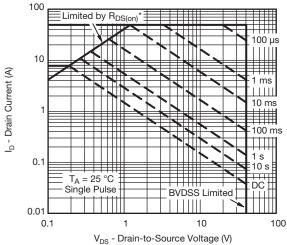
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power (Junction-to-Ambient)



 * V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

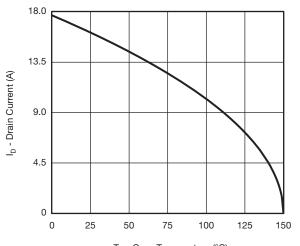
Safe Operating Area, Junction-to-Ambient

- 50

- 25

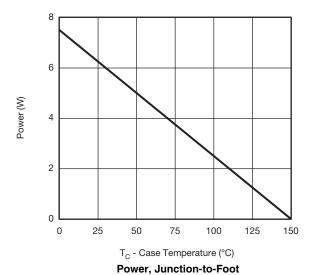


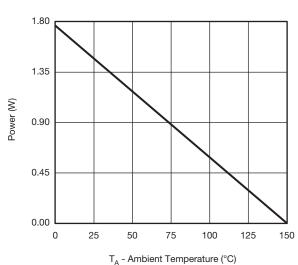
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



 T_C - Case Temperature (°C)

Current Derating*



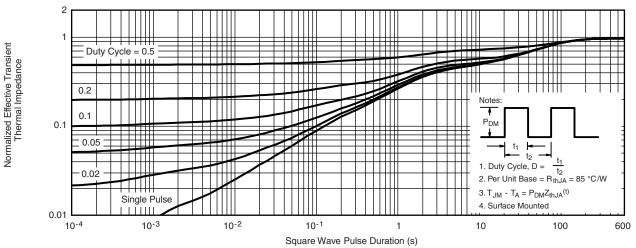


Power, Junction-to-Ambient

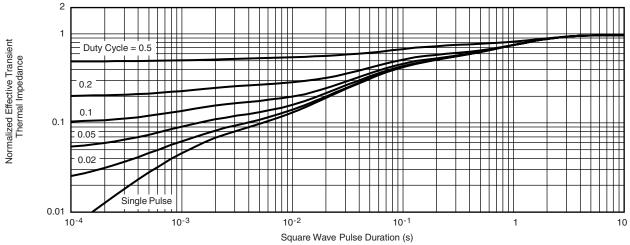
^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



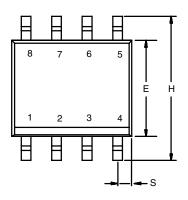
Normalized Thermal Transient Impedance, Junction-to-Ambient



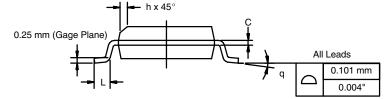
Normalized Thermal Transient Impedance, Junction-to-Foot

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







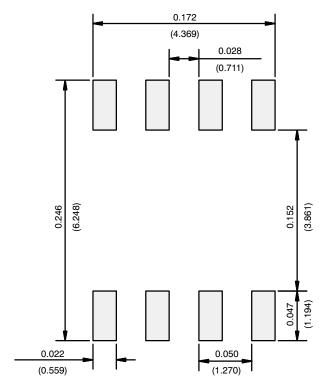
	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050) BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

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RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOT

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